

7	8
REV.	ECN NO.
REVISED	DATE

NOTE:

1.MATERIAL:

a.HOUSING:PPA

b.CONTACT:PHOSPHOR BRONZE

(SURFACE PLATING: Au1u")

SEE ORDERING INFORMATION

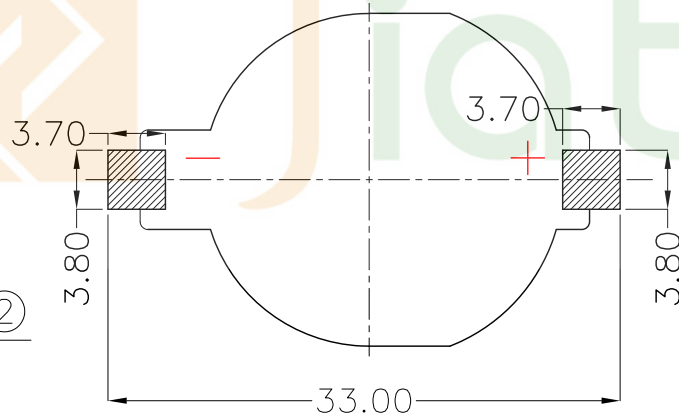
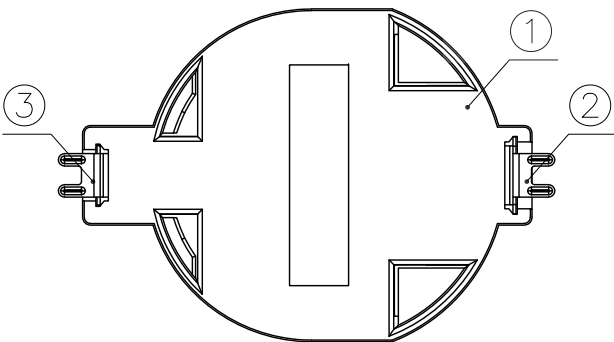
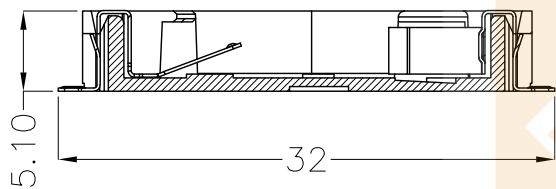
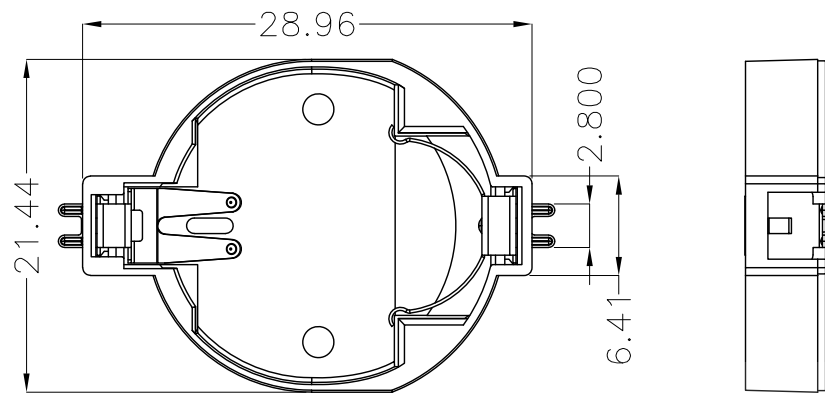
2.ELECTRIC:

a.CONTACT RESISTANCE: 30 MILLIOHMS MAX

b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN

c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL

d.OPERATING TEMPERATURE: -25° C~ +85° C



PCB Layout Diagram
Top View

					UNLESS OTHERWISE SPECIFIED TOLERANCES		Shenzhen Jiatel Hardware Electronics Co.,Ltd www.jiatel.com						
					DECIMALS: X :±0.30 X.X :±0.25 X.XX :±0.20 X.XXX :±0.10		ANGLES: X :±1° X.X :±0.5°		DSND	Wei Peng	DATE	2018-12-20	TITLE: 2032-10 PPA SMT
									CHKD	Fang Cui	DATE	2018-12-20	
									APVD	Eric Zhang	DATE	2018-12-20	PART NO.: JT-BH2032-10
									WEIGHT: 1.21g		SCALE: 2:1	SIZE: A4	
3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating	SHEET 1 OF 1		UNIT: mm		REV.: A/0	OBJECT: JT	DRAW NO.:JT-CP-0178		
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating									
1	HOUSING	1	PPA	BROWN									
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR									
1					5		6		7		8		

3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPA	BROWN
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR